

# **AW-NM191MA**

## **IEEE 802.11b/g/n Wireless LAN LGA Module With M.2 2230 Adaptor Board**

### **Datasheet**

**Rev. C**

**DF**

**(SDIO)**

## Features

### WLAN

- PCIe M.2 TYPE 2230: 30mm(L) x 22mm(W) x 2.91 mm(H)(Max)
- SDIO interface support for WLAN
- High speed wireless connection up to 72.2 Mbps for Wi-Fi
- Multiple power saving modes for low power consumption
- IEEE 802.11i for advanced security
- Support China WAPI
- Lead-free design

## Revision History

Document NO: R2-2191MA-DST-01

Version	Revision Date	DCN NO.	Description	Initials	Approved
A	2020/03/22	DCN016978	● Initial Version	Renton Tao	NC Chen
B	2020/05/25	DCN017352	● Update SDIO interface condition	Renton Tao	NC Chen
C	2021/04/12	DCN021272	● Update datasheet form	Renton Tao	NC Chen

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## 1. Introduction

### 1.1 Product Overview

**AzureWave Technologies, Inc.** introduces the IEEE 802.11b/g/n 1X1WLAN NGFF module --- **AW-NM191MA**. The module is targeted to mobile devices including **Notebook, TV, Tablet and Gaming Device** which need small package module, low power consumption, multiple interfaces and OS support. By using AW-NM191MA, the customers can easily enable the Wi-Fi applications with the benefits of **high design flexibility, short development cycle, and quick time-to-market**.

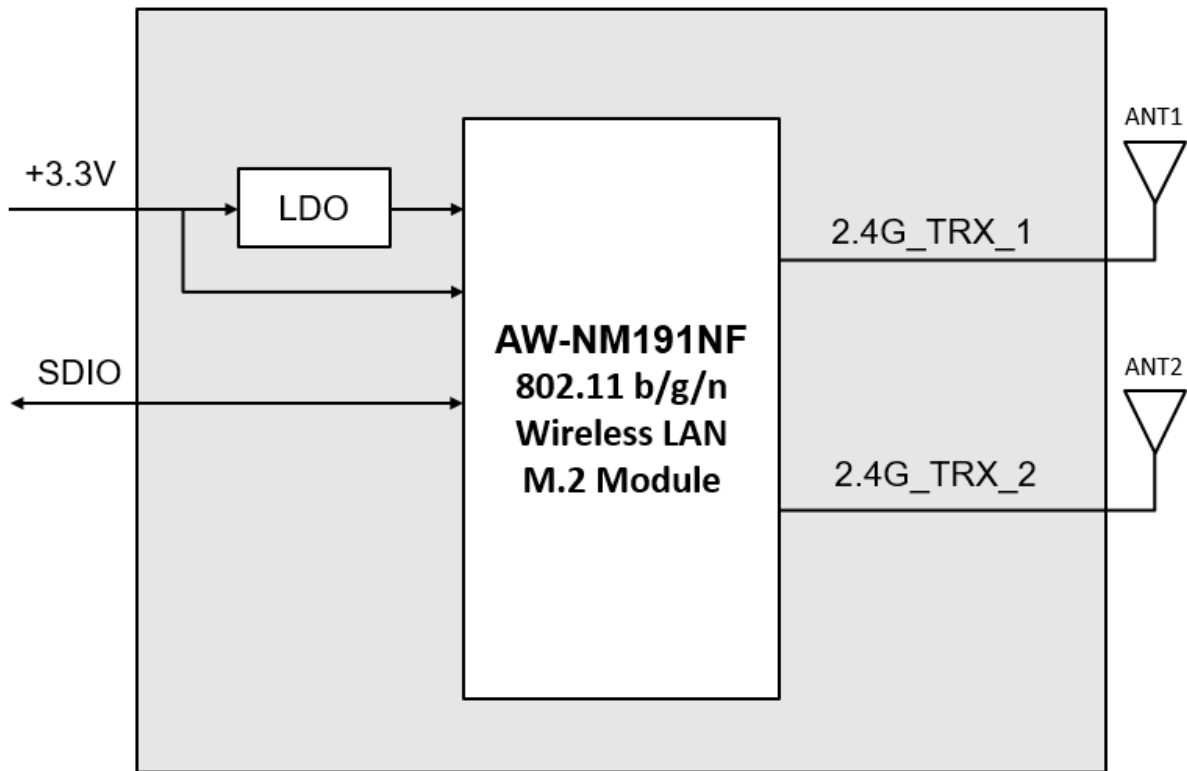
Compliance with the IEEE 802.11b/g/n standard, the AW-NM191MA uses Direct Sequence Spread Spectrum (**DSSS**), Orthogonal Frequency Division Multiplexing (**OFDM**), **DBPSK, DQPSK, CCK** and **QAM** baseband modulation technologies. A high level of integration and full implementation of the power management functions specified in the IEEE 802.11 standard minimize the system power requirements by using AW-NM191MA. In addition to the support of **WPA/WPA2** and **WEP** 64-bit and 128-bit encryption, the AW-NM191MA also supports the **IEEE 802.11i** security standard through the implementation of **Advanced Encryption Standard (AES)/Counter Mode CBC-MAC Protocol (CCMP)**, Wired Equivalent Privacy (**WEP**) with Temporal Key Integrity Protocol (**TKIP**), Advanced Encryption Standard (**AES**)/Cipher-Based Message Authentication Code (**CMAC**), and WLAN Authentication and Privacy Infrastructure (**WAPI**) security mechanisms.

**AW-NM191MA** supports **SDIO interface** for WLAN to the host processor.

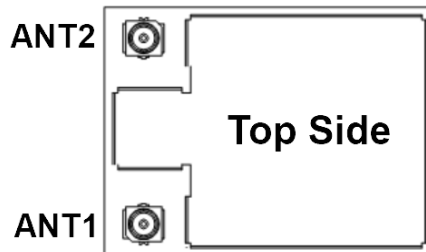
**AW-NM191MA** is suitable for multiple mobile processors for different applications with the support cellular phone co-existence.

**AW-NM191MA** module adopts NXP's latest highly-integrated WLAN SoC---**88W8801**. All the other components are implemented by all means to reach the mechanical specification required.

## 1.2 Block Diagram



### AW-NM191MA Block Diagram



### Module antenna configuration

### 1.3 Specifications Table

#### 1.3.1 General

Features	Description
Product Description	IEEE 802.11b/g/n Wireless LAN LGA Module With M.2 2230 Adaptor Board
Major Chipset	NXP 88W8801
Host Interface	SDIO for WLAN
Dimension	22mm(W) x 30mm(L) x 2.91mm(H) (Tolerance remarked in mechanical drawing)
Form factor	M.2 2230 (E key)
Antenna	I-PEX MHF4 Connector Receptacle (20449) ANT1 : WiFi → TX/RX ANT2 : WiFi → TX/RX
Weight	2.1 g

#### 1.3.2 WLAN

Features	Description																				
WLAN Standard	IEEE 802.11 b/g/n																				
WLAN VID/PID	N/A																				
Frequency Range	2.4 GHz : 2.412 ~ 2.472 GHz																				
Modulation	DSSS, OFDM, DBPSK, DQPSK, CCK, 16-QAM, 64-QAM																				
Number of Channels	<b>2.4GHz</b> ■ USA, NORTH AMERICA, Canada and Taiwan – 1 ~ 11 ■ China, Australia, Most European Countries, Japan – 1 ~ 13																				
Output Power (Board Level Limit)*	<b>2.4GHz</b> <table border="1"> <thead> <tr> <th></th> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Unit</th> </tr> </thead> <tbody> <tr> <td>11b (11Mbps) @EVM&lt;35%</td> <td>15.5</td> <td>17</td> <td>18.5</td> <td>dBm</td> </tr> <tr> <td>11g (54Mbps) @EVM ≤ -27 dB</td> <td>12.5</td> <td>14</td> <td>15.5</td> <td>dBm</td> </tr> <tr> <td>11n (HT20 MCS7) @EVM ≤ -28 dB</td> <td>11.5</td> <td>13</td> <td>14.5</td> <td>dBm</td> </tr> </tbody> </table>		Min	Typ	Max	Unit	11b (11Mbps) @EVM<35%	15.5	17	18.5	dBm	11g (54Mbps) @EVM ≤ -27 dB	12.5	14	15.5	dBm	11n (HT20 MCS7) @EVM ≤ -28 dB	11.5	13	14.5	dBm
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<b>Receiver Sensitivity</b>	<b>2.4GHz</b>				
		Min	Typ	Max	Unit
	11b (11Mbps)	-	-87	-84	dBm
	11g (54Mbps)	-	-73	-70	dBm
	11n (HT20 MCS7)	-	-70	-67	dBm
<b>Data Rate</b>	<ul style="list-style-type: none"> <li>■ 802.11b: 1, 2, 5.5, 11Mbps</li> <li>■ 802.11g: 6, 9, 12, 18, 24, 36, 48, 54Mbps</li> <li>■ 802.11n: up to 72.2Mbps</li> </ul>				
<b>Security</b>	<ul style="list-style-type: none"> <li>■ WAPI</li> <li>■ WEP 64-bit and 128-bit encryption with H/W TKIP processing</li> <li>■ WPA/WPA2 (Wi-Fi Protected Access)</li> <li>■ AES-CCMP hardware implementation as part of 802.11i security standard</li> </ul>				

\* If you have any certification questions about output power please contact FAE directly.

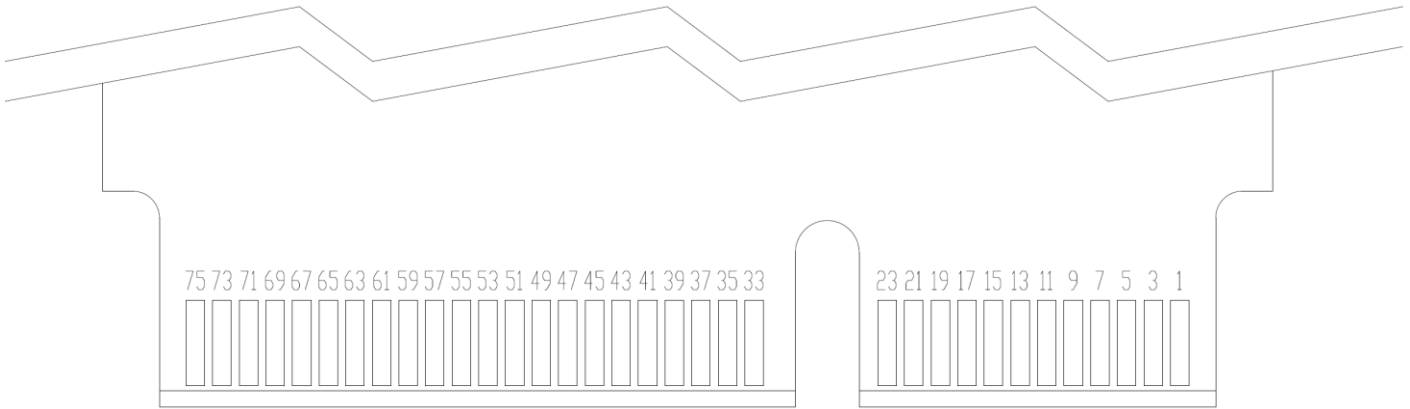
### 1.3.3 Operating Conditions

Features	Description
<b>Operating Conditions</b>	
<b>Voltage</b>	Power supply for host:3.3V
<b>Operating Temperature</b>	0°C ~ 70 °C
<b>Operating Humidity</b>	less than 85% R.H.
<b>Storage Temperature</b>	-40°C ~ 85 °C
<b>Storage Humidity</b>	less than 60% R.H.
<b>ESD Protection</b>	
<b>Human Body Model</b>	+/-2kV
<b>Changed Device Model</b>	+/-500V

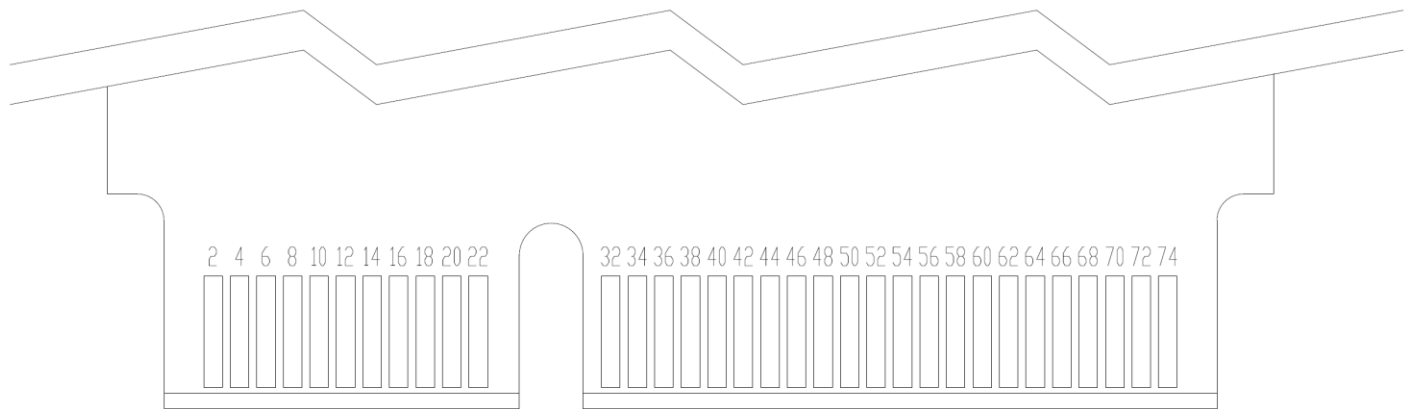


## 2. Pin Definition

### 2.1 Pin Map



**AW-NM191MA Pin Map (Top View)**



**AW-NM191MA Pin Map (Bottom View)**

## 2.2 Pin Table

Pin No	Definition	Basic Description	Voltage	Type
1	GND	Ground	GND	
2	3.3V	3.3V power supply.	Power	3.3V
3	NC	No connect to anything	Floating	
4	3.3V	3.3V power supply	Power	3.3V
5	NC	No connect to anything	Floating	
6	NC	No connect to anything	Floating	
7	GND	Ground	GND	
8	NC	No connect to anything	Floating	
9	SDIO CLK	<b>SDIO 4-bit Mode:</b> Clock input <b>SDIO 1-bit Mode:</b> Clock input <b>SDIO SPI Mode:</b> Clock input	Input	1.8V
10	NC	No connect to anything	Floating	
11	SDIO CMD	<b>SDIO 4-bit Mode:</b> Command/response (input/output) <b>SDIO 1-bit Mode:</b> Command line <b>SDIO SPI Mode:</b> Data input <b>USB Mode:</b> USB_VBUS_ON (input)	Input/Output	1.8V
12	NC	No connect to anything	Floating	
13	SDIO DAT0	<b>SDIO 4-bit Mode:</b> Data line Bit[0] <b>SDIO 1-bit Mode:</b> Data line <b>SDIO SPI Mode:</b> Data output	Input/Output	1.8V
14	NC	No connect to anything	Floating	
15	SDIO DAT1	<b>SDIO 4-bit Mode:</b> Data line Bit[1] <b>SDIO 1-bit Mode:</b> Interrupt <b>SDIO SPI Mode:</b> Interrupt SDO is tristate when SCSn is inactive. Enables multiple devices driving SDO line.	Input/Output	1.8V
16	NC	No connect to anything	Floating	
17	SDIO DAT2	<b>SDIO 4-bit Mode:</b> Data line Bit[2] or read wait (optional) <b>SDIO 1-bit Mode:</b> Read wait (optional) <b>SDIO SPI Mode:</b> Reserved	Input/Output	1.8V
18	GND	Ground.	GND	
19	SDIO DAT3	<b>SDIO 4-bit Mode:</b> Data line Bit[3] <b>SDIO 1-bit Mode:</b> Reserved <b>SDIO SPI Mode:</b> Card select (active low)	Input/Output	1.8V
20	NC	No connect to anything	Floating	
21	NC	No connect to anything	Floating	

22	NC	No connect to anything	Floating	
23	NC	No connect to anything	Floating	
32	NC	No connect to anything	Floating	
33	GND	Ground.	GND	
34	NC	No connect to anything	Floating	
35	NC	No connect to anything	Floating	
36	NC	No connect to anything	Floating	
37	NC	No connect to anything	Floating	
38	NC	No connect to anything	Floating	
39	GND	Ground	GND	
40	NC	No connect to anything	Floating	
41	NC	No connect to anything	Floating	
42	NC	No connect to anything	Floating	
43	NC	No connect to anything	Floating	
44	NC	No connect to anything	Floating	
45	GND	Ground	GND	
46	NC	No connect to anything	Floating	
47	NC	No connect to anything	Floating	
48	NC	No connect to anything	Floating	
49	NC	No connect to anything	Floating	
50	NC	No connect to anything	Floating	
51	GND	Ground	GND	
52	NC	No connect to anything	Floating	
53	NC	No connect to anything	Floating	
54	NC	No connect to anything	Floating	
55	NC	No connect to anything	Floating	
56	PDn	Full Power-Down (input) (active low) The module internal pull-up 51kΩ on this pin.	I	3.3V

57	GND	Ground	GND	
58	NC	No connect to anything	Floating	
59	NC	No connect to anything	Floating	
60	NC	No connect to anything	Floating	
61	NC	No connect to anything	Floating	
62	NC	No connect to anything	Floating	
63	GND	Ground	GND	
64	NC	No connect to anything	Floating	
65	NC	No connect to anything	Floating	
66	NC	No connect to anything	Floating	
67	NC	No connect to anything	Floating	
68	NC	No connect to anything	Floating	
69	GND	Ground	GND	
70	NC	No connect to anything	Floating	
71	NC	No connect to anything	Floating	
72	3.3V	3.3V power supply	Power	
73	NC	No connect to anything	Floating	
74	3.3V	3.3V power supply	Power	
75	GND	Ground	GND	

### 3. Electrical Characteristics

#### 3.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Min	Typ	Max	Units
VIO_SD	Host I/O power supply	--	--	1.8	2.2	V
3.3V	3.3V VBAT input	--	--	3.3	3.63	V
T <sub>storage</sub>	Storage Temperature		-40		125	°C

#### 3.2 Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Typ	Max	Units
VIO_SD	Host I/O power supply	--	1.62	1.8	1.98	V
3.3V	3.3V VBAT input	--	2.97	3.3	3.63	V
T <sub>A</sub>	Ambient operating temperature	--	-30		85	°C

### 3.3 Digital IO Pin DC Characteristics

#### 3.3.1 DC Electricals-1.8V Operation(VIO\_SD)

Symbol	Parameter	Minimum	Typical	Maximum	Unit
VIL	Input low voltage	-0.4	-	0.3*V18	V
VIH	Input high voltage	0.7*V18	-	V18+0.4	V
V <sub>HYS</sub>	Input hysteresis	100	-	-	mV
VOL	Output low voltage	-	-	0.4	V
VOH	Output high voltage	V18-0.4	-	-	V

### 3.4 Host Interface

#### 3.4.1 SDIO Interface

The AW-NM191MA supports a SDIO device interface that conforms to the industry SDIO Full-Speed card specification and allows a host controller using the SDIO bus protocol to access the Wireless SoC device.

The AW-NM191MA acts as the device on the SDIO bus. The host unit can access registers of the SDIO interface directly and can access shared memory in the device through the use of BARs and a DMA engine.

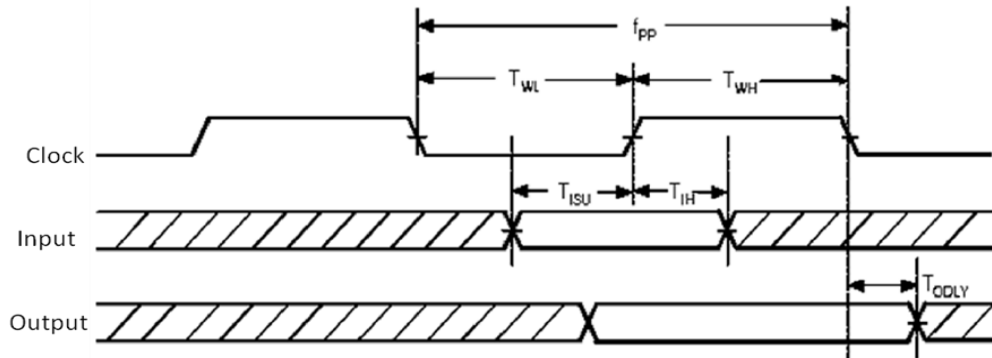
- ◆ On-chip memory used for CIS.
- ◆ Supports 4-bit SDIO and 1-bit SDIO transfer modes.
- ◆ Special interrupt register for information exchange.
- ◆ Allows card to interrupt host.

#### SDIO Interface Signals

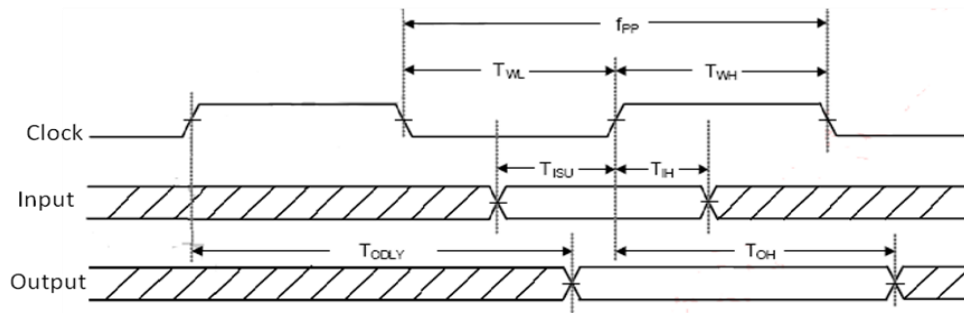
AW-NM191MA SDIO Pin Name	Type	Description
SDIO_DATA_CLK	I	SDIO 4-bit mode: Clock SDIO 1-bit mode: Clock
SDIO_DATA_CMD	I/O	SDIO 4-bit mode: Command line SDIO 1-bit mode: Command line
SDIO_DATA_3	I/O	SDIO 4-bit mode: Data line Bit[3] SDIO 1-bit mode: Not used
SDIO_DATA_2	I/O	SDIO 4-bit mode: Data line Bit[2] or Read Wait (optional) SDIO 1-bit mode: Read Wait (optional)
SDIO_DATA_1	I/O	SDIO 4-bit mode: Data line Bit[1] SDIO 1-bit mode: Interrupt
SDIO_DATA_0	I/O	SDIO 4-bit mode: Data line Bit[0] SDIO 1-bit mode: Data line

### 3.4.1.1 SDIO Protocol Timing

Default Speed, High-Speed Modes



SDIO protocol timing Diagram - Default mode.



SDIO protocol timing Diagram - High Speed mode.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f <sub>pp</sub>	CLK Frequency	Normal	0	--	25	MHz
		High Speed	0	--	50	MHz
T <sub>WH</sub>	CLK High Time	Normal	10	--	--	ns
		High Speed	7	--	--	ns
T <sub>WL</sub>	CLK Low Time	Normal	10	--	--	ns
		High Speed	7	--	--	ns
T <sub>ISU</sub>	Input Setup Time	Normal	5	--	--	ns
		High Speed	6	--	--	ns
T <sub>IH</sub>	Input Hold Time	Normal	5	--	--	ns
		High Speed	2	--	--	ns
T <sub>ODLY</sub>	Output Delay Time	Normal	--	--	14	ns
	CL ≤ 40pF (1 card)	High Speed	--	--	14	ns
T <sub>OH</sub>	Output Hold Time	High Speed	2.5	--	--	ns

SDIO Timing Data – Default Speed / High-Speed modes.

### **3.5 Power up Sequence**

The AW-NM191MA is reset, and the internal CPU begins the boot sequence when the PDn input pin transitions from low to high following NXP's power up sequence.

PDn pin has internal 10k ohm resistor pull-up to 3.3V.

#### **3.5.1 Reset Configuration**

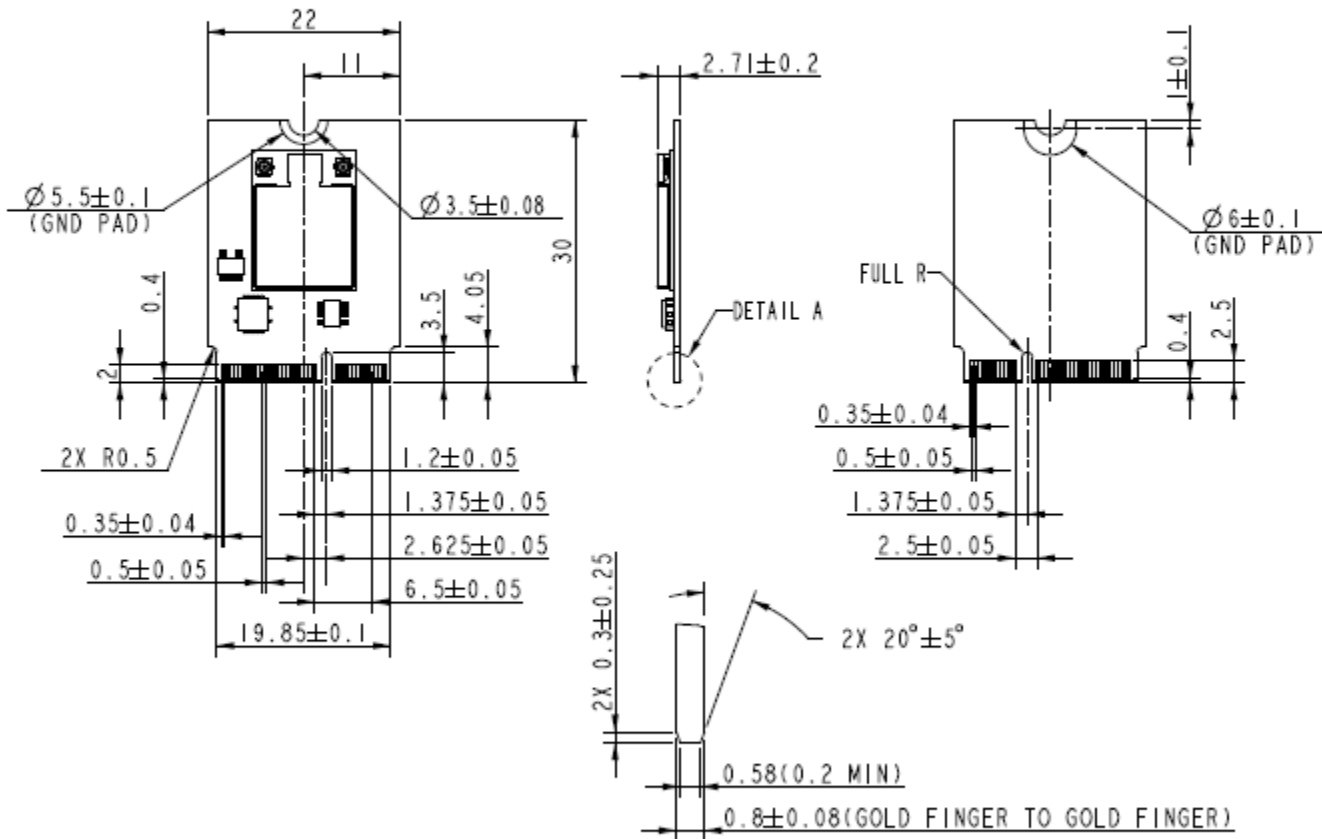
The AW-NM191MA is reset to its default operating state under the following conditions:

- Power-on reset (POR)
- Software/Firmware reset
- External pin for power down (PDn)



## 4. Mechanical Information

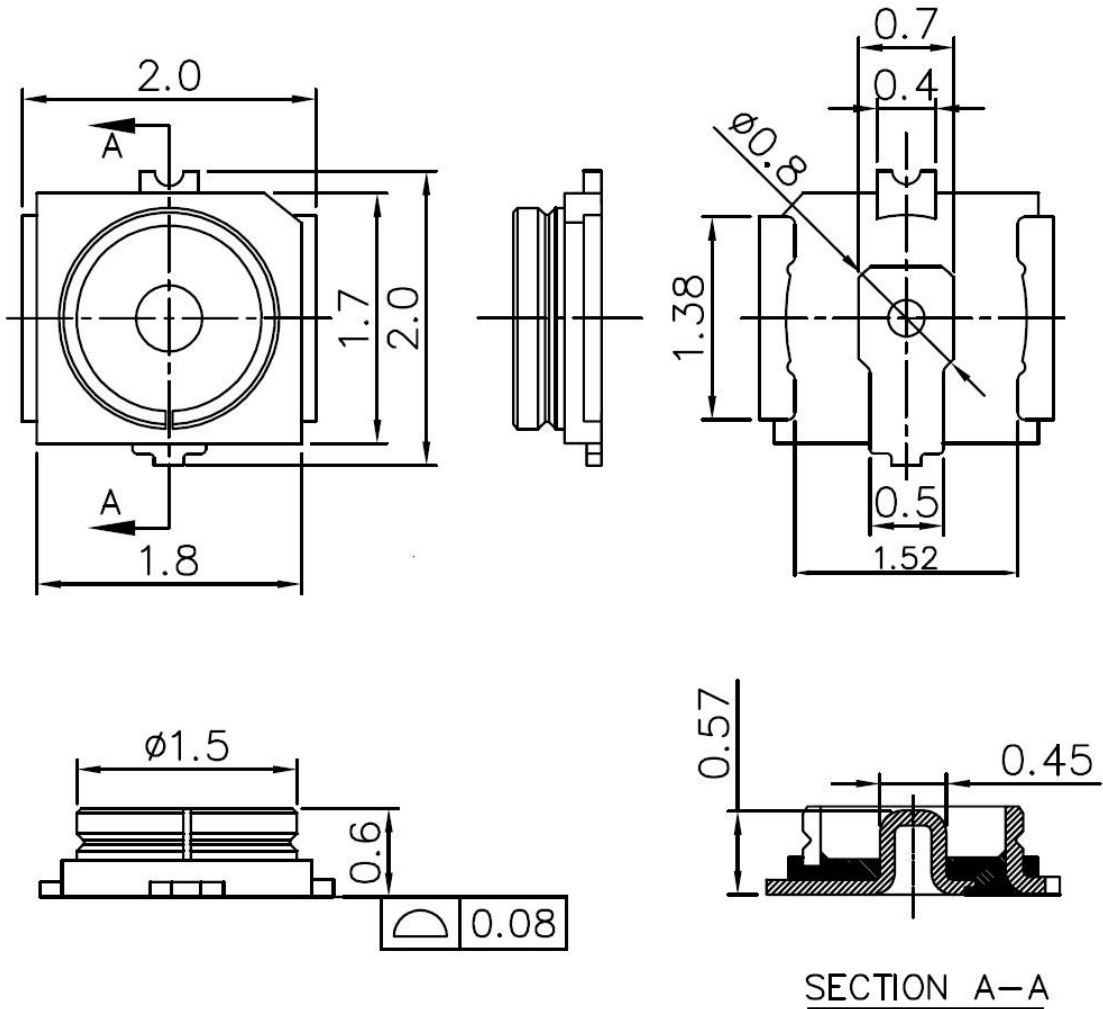
### 4.1 Mechanical Drawing



DETAIL: A  
SCALE: 4.000

TOLERANCES UNLESS OTHERWISE SPECIFIED:  $\pm 0.15 \text{ mm}$

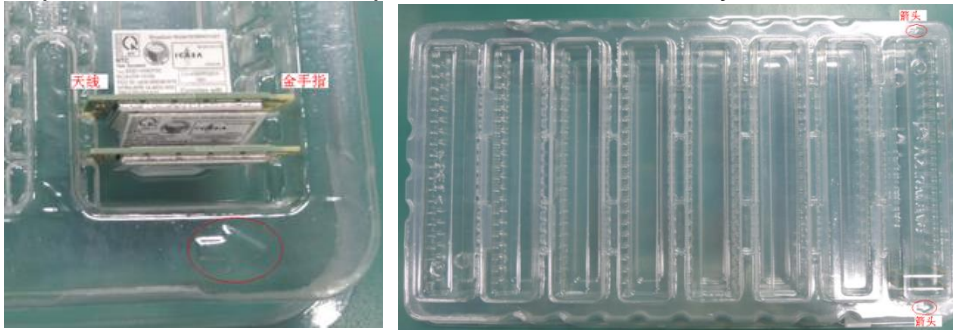
## 4.2 Antenna connector drawing



UNITS: mm

## 5. Packaging Information

1. 160pcs M.2 2230 modules put in the one bottom tray



2. One cover tray put on bottom tray



3. 5pcs tray (cover + bottom) stacked together



4. Use P.P Strap to pack 5 trays



5. Put packed trays into inner box



6. Seal the inner box by AzureWave tape



7. One package label pasted in side of inner box



Example:



8. Two inner boxes put into one carton; If only one inner box has modules, "Empty" label pasted on the other one inner box



Example:














9. Seal the carton by AzureWave tape





10. One carton label and box label pasted on the carton. If the carton is not full, one balance label pasted on the carton



<p>Example of carton label</p>	 <table border="1"> <tr> <td colspan="2" style="text-align: center;"></td> </tr> <tr> <td>AzureWave P/N</td> <td></td> </tr> <tr> <td>Customer</td> <td>由業務提供</td> </tr> <tr> <td>Customer P/N</td> <td>由業務提供</td> </tr> <tr> <td>Customer PO</td> <td>由業務提供</td> </tr> <tr> <td>Description</td> <td>AW-XXXXXX</td> </tr> <tr> <td>QTY</td> <td>1200 pcs</td> </tr> <tr> <td>C/N</td> <td></td> </tr> <tr> <td>N.W.</td> <td>G.W.</td> </tr> <tr> <td colspan="2" style="text-align: center;"></td> </tr> </table>			AzureWave P/N		Customer	由業務提供	Customer P/N	由業務提供	Customer PO	由業務提供	Description	AW-XXXXXX	QTY	1200 pcs	C/N		N.W.	G.W.		
																					
AzureWave P/N																					
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Description	AW-XXXXXX																				
QTY	1200 pcs																				
C/N																					
N.W.	G.W.																				
																					
<p>Example of box label</p>																					
<p>Example of production label</p>	 <p>P/N: </p> <p>D/C: 1309 </p> <p>PCK NO.: PCKNO0069097 </p> <p>QTY: 294 </p> <p>BAG SEAL DATE: _____</p>																				
<p>Example of balance label</p>	